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LESSO 联塑

CHINA LESSO GROUP HOLDINGS LIMITED

中國聯塑集團控股有限公司

(Incorporated in the Cayman Islands with limited liability)

(Stock Code: 2128)

**UPDATE ON THE PROPOSED SPIN-OFF AND SEPARATE LISTING OF
EDA GROUP HOLDINGS LIMITED ON THE MAIN BOARD OF
THE STOCK EXCHANGE OF HONG KONG LIMITED**

GLOBAL OFFERING AND FINAL OFFER PRICE

The Company announces that EDA has fixed the final offer price of the EDA Shares under the Global Offering at HK\$2.28 per EDA Share (exclusive of brokerage of 1.0%, SFC transaction levy of 0.0027%, AFRC transaction levy of 0.00015% and Stock Exchange trading fee of 0.00565%).

Please refer to the announcement published by EDA on its website (www.edayun.cn) and the website of the Stock Exchange (www.hkexnews.hk) on 27 May 2024 for information in respect of, among other things, the results and allocation of the EDA Shares under the Global Offering.

Shareholders and other investors should be aware that there is no assurance that the Proposed Spin-off will take place or as to when it may take place. If the Proposed Spin-off does not proceed for any reason, the Preferential Offering will not proceed. Shareholders and other investors are reminded to exercise caution when dealing in the securities of the Company. Any person who is in doubt about his/her/its position or any action to be taken is recommended to consult his/her/its own professional advisers.

INTRODUCTION

Reference is made to the Company's announcements dated 26 June 2023, 25 April 2024, 6 May 2024, 17 May 2024 and 20 May 2024 regarding the Proposed Spin-off and separate listing of EDA on the Main Board of the Stock Exchange (the "**Announcements**"). Unless otherwise specified, capitalised terms used in this announcement shall have the same meanings as those defined in the Announcements.

APPLICATION AND ALLOCATION OF GLOBAL OFFERING

Please refer to the announcement published by EDA on its website (www.edayun.cn) and the website of the Stock Exchange (www.hkexnews.hk) on 27 May 2024 for information in respect of, among other things, the results and allocation of the EDA Shares under the Global Offering (the "**Announcement of Allotment Results**").

FINAL OFFER PRICE

EDA has fixed the final offer price of the EDA Shares under the Global Offering at HK\$2.28 per EDA Share (exclusive of brokerage of 1.0%, SFC transaction levy of 0.0027%, AFRC transaction levy of 0.00015% and Stock Exchange trading fee of 0.00565%).

As disclosed in the Announcement of Allotment Results, no Over-allotment Option will be exercised. If the Global Offering proceeds at the final offer price of HK\$2.28 per EDA Share, the market capitalisation of EDA immediately after completion of the Global Offering will be approximately HK\$1,003.1 million.

INTERNATIONAL PLACING AGREEMENT

On 24 May 2024, the International Placing Agreement was entered into by, among others, EDA, the Company and the International Underwriters. Under the International Placing Agreement, the International Underwriters have agreed, subject to certain conditions set out therein, to subscribe for or purchase, or procure subscribers or purchasers to subscribe for or purchase the EDA Shares being offered under the International Offering at the final offer price of HK\$2.28 per EDA Share (exclusive of brokerage of 1.0%, SFC transaction levy of 0.0027%, AFRC transaction levy of 0.00015% and Stock Exchange trading fee of 0.00565%).

LISTING DATE

Assuming the Global Offering is completed in accordance with the current timetable, (i) EDA is expected to be listed on the Main Board of the Stock Exchange on 28 May 2024 and (ii) the dealing of the EDA Shares will commence at 9:00 a.m. on 28 May 2024 on the Main Board of the Stock Exchange. The EDA Shares will be traded in board lots of 1,000 shares and the stock code is 2505.

DEFINITIONS

In this announcement, the following expressions have the meanings set out below unless the context requires otherwise:

Terms	Definition
“Board”	the board of the Company
“Company”	China Lesso Group Holdings Limited
“EDA”	EDA Group Holdings Limited, previously known as EDA Cloud Technology Holdings Limited (易達雲科技控股有限公司)
“International Placing”	the conditional placing of the International Placing EDA Shares with professional and institutional investors for cash at the Offer Price, and outside the United States to investors that are not U.S. Persons nor persons acquiring for the account or benefit of U.S. Persons in offshore transactions in reliance on Regulation S and the applicable laws of the jurisdiction where those offers and sales occur
“International Placing Agreement”	the international placing agreement expected to be entered into on or around 24 May 2024 by, among others, EDA and the International Underwriters in respect of the International Placing
“International Underwriters”	the underwriter(s) for the International Placing who are expected to enter into the International Placing Agreement to underwrite the International Placing

“Listing Rules”	the Rules Governing the Listing of Securities on the Stock Exchange
“SFC”	the Securities and Futures Commission of Hong Kong
“SFO”	the Securities and Futures Ordinance (Chapter 571 of the Laws of Hong Kong), as amended or supplemented from time to time

By Order of the Board
China Lesso Group Holdings Limited
Wong Luen Hei
Chairman

Hong Kong, 27 May 2024

As at the date of this announcement, the executive directors of the Company are Mr. Wong Luen Hei, Mr. Zuo Manlun, Ms. Zuo Xiaoping, Mr. Lai Zhiqiang, Mr. Kong Zhaocong, Mr. Chen Guonan, Dr. Lin Shaoquan, Mr. Luo Jianfeng and Dr. Song Keming; and the independent non-executive directors of the Company are Dr. Tao Zhigang, Mr. Cheng Dickson, Ms. Lu Jiandong, Dr. Hong Ruijiang and Ms. Lee Vanessa.